AUTOMOTIVE GRADE

RoHS

COMPLIANT

HALOGEN FREE



Vishay General Semiconductor

Surface-Mount Standard Rectifiers

eSMP® Series



SMF (DO-219AB)

Cathode O Anode

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	1.0 A			
V _{RRM}	400 V			
I _{FSM}	25 A			
V_F at $I_F = 0.7$ A $(T_J = 125 ^{\circ}C)$	0.83 V			
I _R	5 μΑ			
T _J max.	175 °C			
Package	SMF (DO-219AB)			
Circuit configuration	Single			

FEATURES

- · Glass passivated pellet chip junction
- · Low profile package
- · Ideal for automated placement
- Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- · Wave and reflow solderable
- AEC-Q101 qualified available
- Compatible to SOD-123W package case outline
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - for halogen-free, RoHS-compliant Base P/NHM3 - for halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	SEG10FG	UNIT	
Device marking code		GG		
Maximum repetitive peak reverse voltage	V _{RRM}	400	V	
Maximum DC forward current	I _{F(AV)} (1)	1.0	Α	
Peak forward surge current 8.3 ms single half sine-wave	I _{FSM}	25	Α	
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175	°C	

Notes

(1) Free air, mounted on recommended PCB, 2 oz. pad area



ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 0.1 A	T _J = 25 °C		0.82	-	V
	$I_F = 0.7 A$			0.95	1.1	V
	I _F = 1.0 A		V _E (1)	1.0	-	
	I _F = 0.1 A	T _J = 125 °C	VF(I)	0.67	-	
	$I_F = 0.7 A$			0.83	-	
	I _F = 1.0 A			0.88	-	
Reverse current	Rated V _R	T _J = 25 °C	I _R ⁽²⁾	-	5	
	nateu v _R	T _J = 125 °C		-	50	- μΑ
Typical reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	1200	-	ns
Typical junction capacitance	4.0 V, 1 MHz		CJ	7.3	1	pF

Notes

 $^{(1)}$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °c unless otherwise noted)				
PARAMETER	SYMBOL	SEG10FG	UNIT	
Typical thermal resistance	R _{0JA} (1)(2)	130	°C/W	
	R _{0JM} (3)	14	C/VV	

Notes

- $^{(1)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$
- (2) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance R_{θJA} junction to ambient to follow JEDEC® 51-2A
- $^{(3)}$ Mounted on infinite heatsink thermal resistance $R_{\theta JM}$ junction to mount to follow JEDEC $^{(8)}$ 51-14 transient dual interface test method (TDIM)

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS (T _A = 25 $^{\circ}$ C unless otherwise noted)						
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE	
AEC-Q101-001	Human body model (contact mode)	$C = 100 \text{ pF}, R = 1.5 \text{ k}\Omega$	V_{C}	НЗВ	> 8kV	
ISO-10605	Human body model (contact mode)	$C = 330 \text{ pF}, R = 2 \text{ k}\Omega$	V_{C}	-	> 25 kV typ.	

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
SEG10FG-M3/H	0.015	Н	3000	7" diameter plastic tape and reel	
SEG10FG-M3/I	0.015	I	10 000	13" diameter plastic tape and reel	
SEG10FGHM3/H (1)	0.015	Н	3000	7" diameter plastic tape and reel	
SEG10FGHM3/I (1)	0.015	I	10 000	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

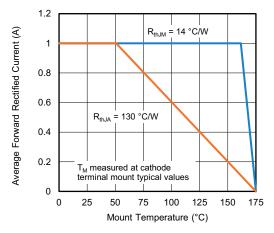


Fig. 1 - Maximum Forward Current Derating Curve

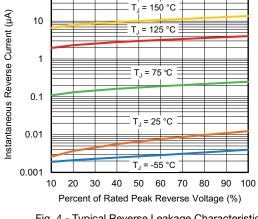


Fig. 4 - Typical Reverse Leakage Characteristics

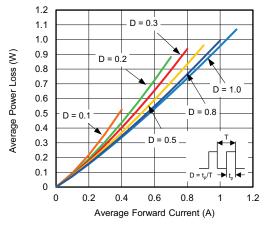


Fig. 2 - Average Power Loss Characteristics

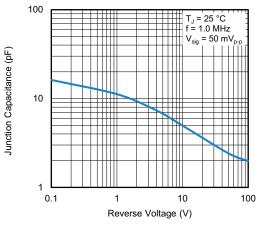


Fig. 5 - Typical Junction Capacitance

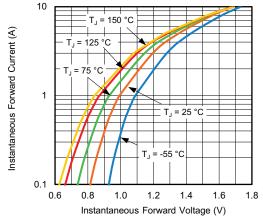


Fig. 3 - Typical Instantaneous Forward Characteristics

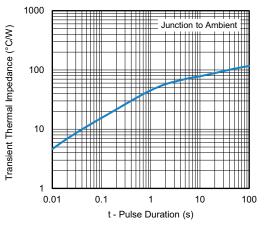


Fig. 6 - Typical Transient Thermal Impedance



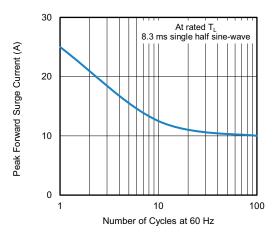
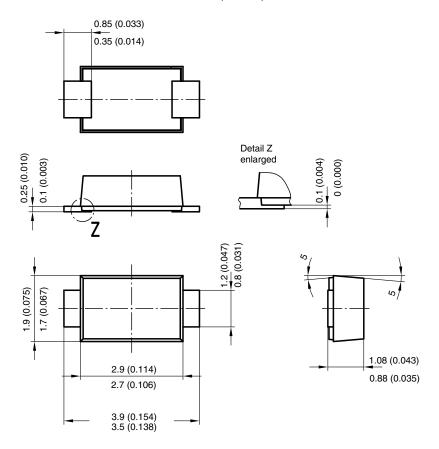


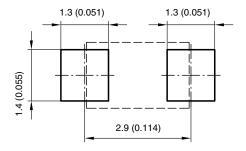
Fig. 7 - Maximum Non-Repetitive Peak Forward Surge Current Number of Cycles



PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



Foot print recommendation:



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